



N-Channel 150-V (D-S) MOSFET

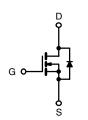
PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)			
150	0.085 at V _{GS} = 10 V	4.8			
	0.095 at V _{GS} = 6.0 V	4.5			

FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFETs for Fast Switching
- New Low Thermal Resistance PowerPAK[®]
 Package with Low 1.07 mm Profile
- PWM Optimized
- 100 % R_g Tested

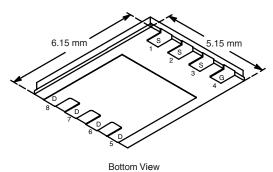
APPLICATIONS

- DC/DC Power Supply Primary Side Switch
- Industrial Motor Drives



N-Channel MOSFET

PowerPAK SO-8



Ordering Information: Si7898DP-T1-E3 (Lead (Pb)-free)

Si7898DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T	$_{A}$ = 25 °C, unles	ss otherwise n	oted			
Parameter	Symbol	10 s	Steady State	Unit		
Drain-Source Voltage	V_{DS}	150		V		
Gate-Source Voltage	V_{GS}	± 20				
Continuous Drain Current /T 150 °C\8	T _A = 25 °C	- I _D	4.8	3.0		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		3.8	2.4		
Pulsed Drain Current		I _{DM}	25		Α	
Avalanche Current	L = 0.1 mH		10			
Continuous Source Current (Diode Conduction) ^a	I _S	4.1	1.6			
Mariana Barra Birata di ang	T _A = 25 °C	P _D	5.0	1.9	W	
Maximum Power Dissipation ^a	T _A = 70 °C	T rD	3.2	1.2	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150 260		°C	
Soldering Recommendations (Peak Temperature) ^{b,c}		·				

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	20	25		
Maximum Junction-to-Ambient	Steady State	' 'thJA	52	65	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	2.1	2.6		

Notes

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.



Vishay Siliconix



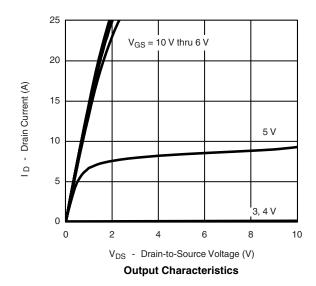
SPECIFICATIONS T _J = 25 °C, unless otherwise noted						
Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zoro Cata Valtaga Drain Current	lana	V _{DS} = 150 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V, T _J = 55 °C			5	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α
5	В	V _{GS} = 10 V, I _D = 3.5 A		0.068	0.085	0
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 6.0 \text{ V}, I_D = 3.0 \text{ A}$		0.076	0.095	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 5 A		15		S
Diode Forward Voltage ^a	V_{SD}	I _S = 2.5 A, V _{GS} = 0 V		0.75	1.2	V
Dynamic ^b				•	•	
Total Gate Charge	Q_g			17	21	
Gate-Source Charge	Q _{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 3.5 \text{ A}$		3.2		nC
Gate-Drain Charge	Q_{gd}			6.0		
Gate Resistance	R_g		0.5	0.85	2.5	Ω
Turn-On Delay Time	t _{d(on)}			9.0	14	
Rise Time	t _r	V_{DD} = 75 V, R_L = 21 Ω		10	15	İ
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 3.5$ A, V_{GEN} = 10 V, R_g = 6 Ω		24	35	ns
Fall Time	t _f			17	25	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.5 A, dI/dt = 100 A/μs		45	70	

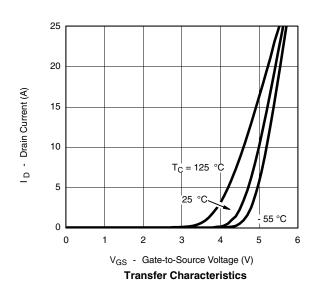
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



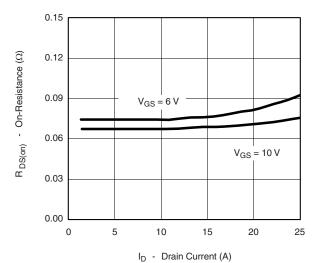




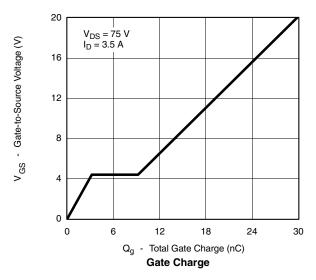


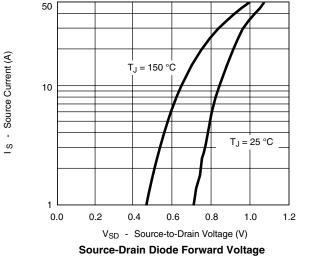


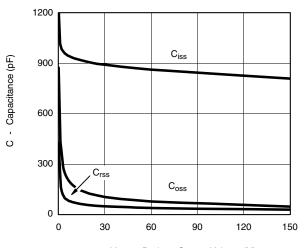
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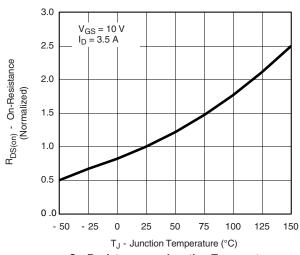


On-Resistance vs. Drain Current

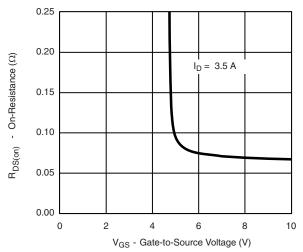








On-Resistance vs. Junction Temperature

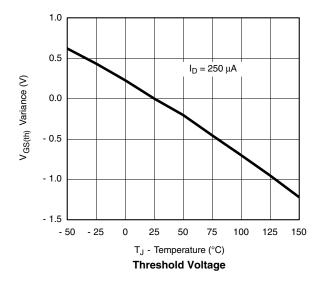


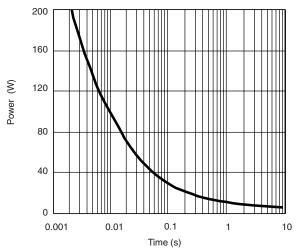
On-Resistance vs. Gate-to-Source Voltage

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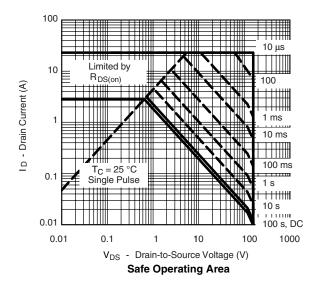
VISHAY

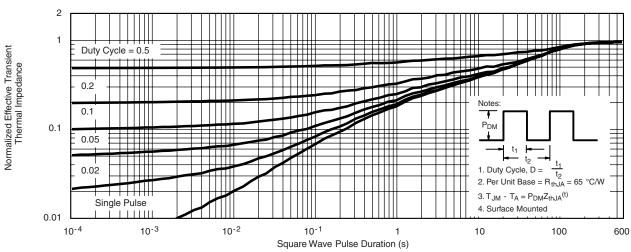
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





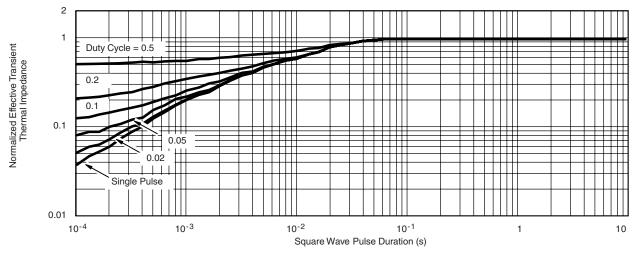
Single Pulse Power, Junction-to-Ambient







TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71873.



DWG: 5881

PowerPAK® SO-8, (Single/Dual)



	3. Dimensions exclusive of mold flash and cutting burrs.							
DIM.		MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
A	0.97	1.04	1.12	0.038	0.041	0.044		
A1		-	0.05	0	-	0.002		
b	0.33	0.41	0.51	0.013	0.016	0.020		
С	0.23	0.28	0.33	0.009	0.011	0.013		
D	5.05	5.15	5.26	0.199	0.203	0.207		
	4.00	4.00	F 00	0.400	0.400	0.407		

Α	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	-	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4		0.57 typ.			0.0225 typ.		
D5		3.98 typ.			0.157 typ.		
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2 (for AL product)	3.30	3.48	3.66	0.130	0.137	0.144	
E2 (for other product)	3.48	3.66	3.84	0.137	0.144	0.151	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4 (for AL product)		0.58 typ.			0.023 typ.		
E4 (for other product)		0.75 typ.		0.030 typ.			
е		1.27 BSC		0.050 BSC			
K (for AL product)		1.45 typ.		0.057 typ.			
K (for other product)		1.27 typ.		0.050 typ.			
K1	0.56	-	=	0.022	-	=	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
M	0.125 typ.			0.005 typ.			
ECN: C13-0702-Rev. K, 20)-May-13			•			

Revison: 20-May-13 Document Number: 71655



RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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Revision: 02-Oct-12 Document Number: 91000